ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® MAterial Comp © Copyright 2005. I international and Par	PC, Bannock	burn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar the declaratio	ration of n encon	f the substanc npasses all lov	es within wer level	the manufact materials for	turer listed i which the n	em. No anufac	ote: if the cturer has	item is an as engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Tyj http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					erials and M	ials and Mfg Information				
Supplier Information															
Company name*	Company un	Company unique ID			Unique ID Authority					Respons	Response Date*				
onsemi											2024-05	2024-05-16			
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email -	Email - Contact*				
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA					Produc	Product-Env-Stewards@onsemi.com				
uthorized Representative*	Title - Representative			Phone - Representative*				Email -	Email - Representative*						
Product-Env-Stewards	Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Iter	n Number					ate Ve	ersion	Manufacturing Site TH6		,	Weight	t*	UOM	Unit Type
	CAT360	51HV3-GT2				2024-05-16					:	20.17		mg	Each
Ianufacturing Proccess Informa	tion					- 			-					1	I
Terminal Plating / Grid Array M	aterial '	Terminal Base	Alloy	J-STD-020 MSL Ratin		Peak Process I		Body Temperature Max Time at Peal		ak Temperat	Temperature Numbe		f Reflow Cyc	les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		C	30	30		ds 3	3		
comments															
evel 1 - maximum time at peak temperat	ire during so	ldering is 10-3	0 seconds												
or more information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.73	mg	Supplier	Silicon (Si)	7440-21-3		0.73	mg
Die Attach	0.29	mg	Supplier	Silver (Ag)	7440-22-4		0.2175	mg
			Supplier	Epoxy resins	129915-35-1		0.0725	mg
Lead Frame	8.28	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0124	mg
			Supplier	Silicon (Si)	7440-21-3		0.0538	mg
			В	Nickel (Ni)	7440-02-0		0.2484	mg
			Supplier	Copper (Cu)	7440-50-8		7.9654	mg
Mold Compound-Black	10.51	mg		Epoxy Phenol Resin	proprietary data		1.1035	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		9.4065	mg
Plating	0.1	mg	Supplier	Palladium (Pd)	7440-05-3		0.0062	mg
			В	Nickel (Ni)	7440-02-0		0.0927	mg
			Supplier	Gold (Au)	7440-57-5		0.0011	mg
Wire Bond - Au	0.26	mg	Supplier	Gold (Au)	7440-57-5		0.26	mg